

Features

- Advanced trench process technology
- Extremely low on-resistance $R_{DS(on)}$
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Fast Switching
- High Ruggedness

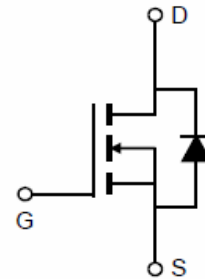
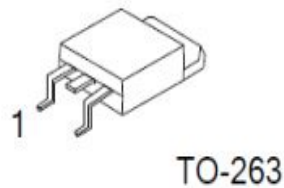
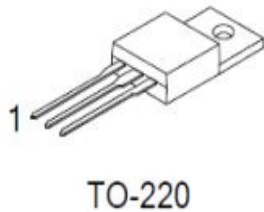
Product Summary

V _{DS}	80V
$R_{DS(on)}@V_{GS}=10V$	5.7 mΩ
I _D	100A

Application

- Motor Drives
- UPS (Uninterruptible Power Supplies)
- DC/DC converter
- General purpose applications

Part ID	Package Type	Marking
SFP120N80	TO-220	100N80
SFB120N80	TO-263	100N80



Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	80	V
Continuous drain current $T_C = 25^\circ C$	I_D	100	A
$T_C = 100^\circ C$		80	
Pulsed drain current $T_C = 25^\circ C, t_p$ limited by T_{jmax}	$I_{D\ pulse}$	480	
Avalanche energy, single pulse (L=1mH,Rg=25Ω, ID=sweep(14A~46A))	E_{AS}	1000	mJ
Gate-emitter voltage	V_{GS}	±25	V
Power dissipation $T_C = 25^\circ C$	P_{tot}	178	W
Operating junction and storage temperature	T_j, T_{stg}	-55...+150	°C

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal resistance, junction – case. Max	R_{thJC}	0.66	°C/W
Thermal resistance, junction – ambient. Max	R_{thJA}	62.0	

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Test Condition	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	80	85	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$ $T_j=25^\circ C$ $T_j=125^\circ C$	2.0 -	3.0	4.0 -	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=64V, V_{GS}=0V$ $T_j=25^\circ C$ $T_j=125^\circ C$	- -	0.05 -	1 5	μA
Gate-source leakage current	I_{GSS}	$V_{GS}=20V, V_{DS}=0V$	-	1	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=40A,$ $T_j=25^\circ C$	-	5.6	7.0	mΩ

Dynamic Characteristic

Input Capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=40V,$ $f=1MHz$	-	3240	-	pF
Output Capacitance	C_{oss}		-	1200	-	
Reverse Transfer Capacitance	C_{rss}		-	28.0	-	
Gate Total Charge	Q_G	$V_{GS}=10V, V_{DS}=40V,$ $I_D=50A, f=1MHz$	-	59.0	-	nC
Gate-Source charge	Q_{gs}		-	13.0	-	
Gate-Drain charge	Q_{gd}		-	11.0	-	
Turn-on delay time	$t_{d(on)}$	$T_j=25^\circ C, V_{GS}=10V,$ $V_{DS}=40V, R_L=3\Omega$	-	23.2	-	ns
Rise time	t_r		-	42.4	-	
Turn-off delay time	$t_{d(off)}$		-	48.6	-	
Fall time	t_f		-	25.7	-	
Gate resistance	R_G	$V_{GS}=0V, V_{DS}=0V,$ $f=1MHz$	-	1.7	-	Ω

Body Diode Characteristic

Body Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_{SD}=30A$	-	0.80	1.3	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F=20A,$ $dI/dt=500A/\mu s$		63		ns
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F=20A,$ $dI/dt=500A/\mu s$		630		nC

Figure 1. Gate-Charge Characteristics

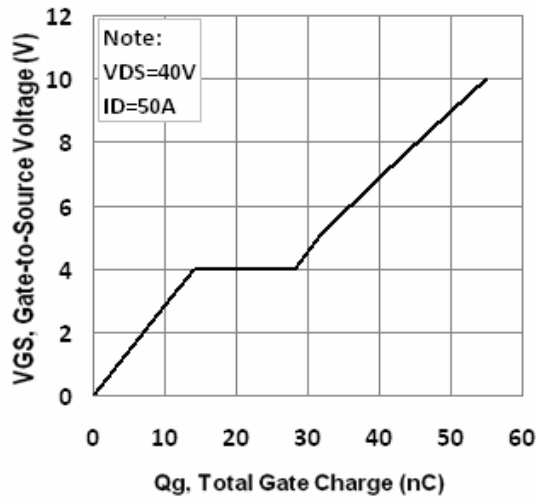


Figure 2. Capacitance Characteristics

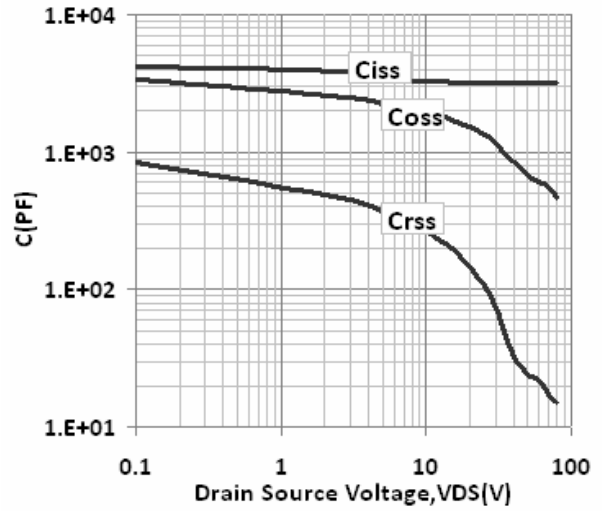


Figure 9: Normalized Maximum Transient Thermal Impedance (R_{thJC})

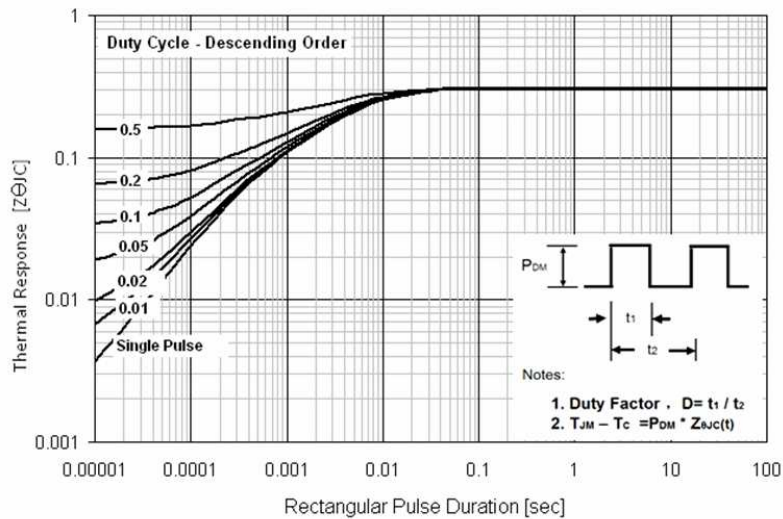
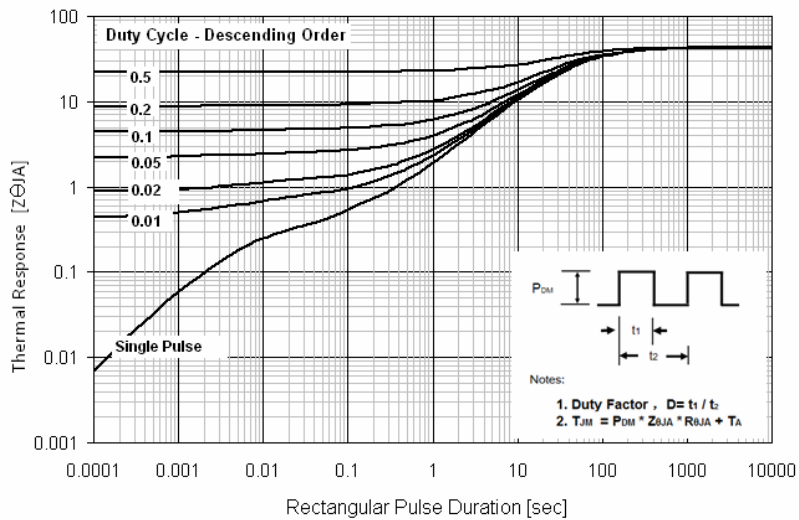
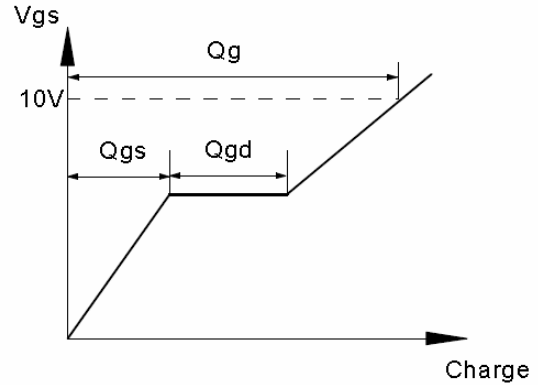
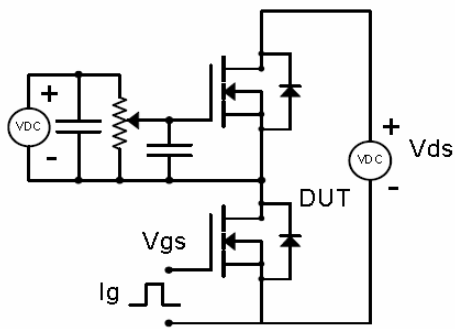


Figure 3: Normalized Maximum Transient Thermal Impedance (R_{thJA})

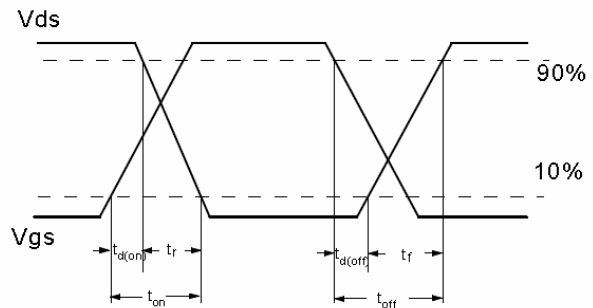
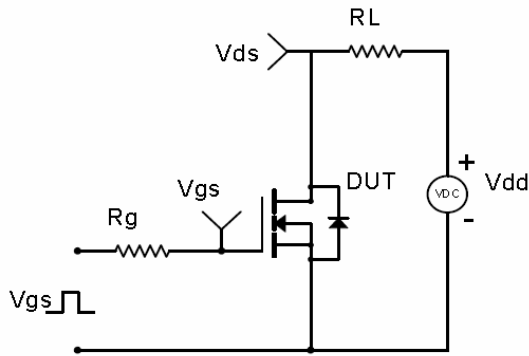


Test Circuit & Waveform

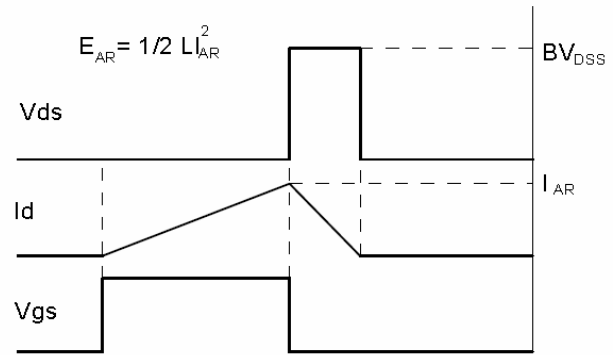
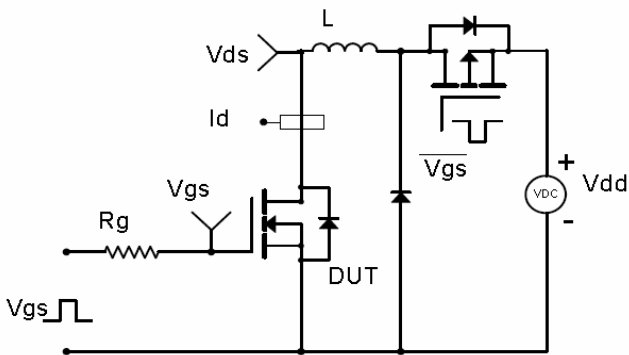
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

